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## GbE Line Card Synchronizer

Shortform Data Sheet

March 2007

A full Data Sheet is available to qualified customers. To register, please send an email to TimingandSync@zarlink.com.

#### **Features**

- Single chip low cost solution for synchronizing an Ethernet PHY to a standard telecom clock
- Generates an IEEE 802.3 jitter compliant 25 MHz Gigabit Ethernet output clock
- Supports three modes of operation: Asynchronous Freerun, Synchronous, and Asynchronous Holdover
- Defaults in Asynchronous Freerun mode
- In Asynchronous Freerun mode, the DPLL generates an output clock with a frequency accuracy equal to frequency accuracy of the external crystal oscillator (XO) or a low cost crystal (XTAL)
- In Synchronous mode, the DPLL automatically synchronizes to one of a pre-defined set of frequencies including 2 kHz, 8 kHz, 64 kHz, 1.544 MHz, 2.048 MHz, 6.48 MHz, 8.192 MHz, 16.384 MHz, 19.44 MHz, 38.88 MHz, 77.76 MHz.

#### **Ordering Information**

ZL30107GGG 64 Pin CABGA Trays
ZL30107GGG2 64 Pin CABGA\* Trays
\*Pb Free Tin/Silver/Copper

#### -40°C to +85°C

- Configurable to accept a 25 MHz input reference
- Automatic entry into Asynchronous Holdover mode when all input references fail
- Input reference is manually selectable through the serial (SPI) interface
- · Hitless input reference switching
- Lock indicator pin
- · Input reference status monitors
- Programmable loop bandwidth of 14 Hz, 28 Hz, or 890 Hz

#### **Applications**

 Ethernet Line Cards Supporting Synchronous Transmission

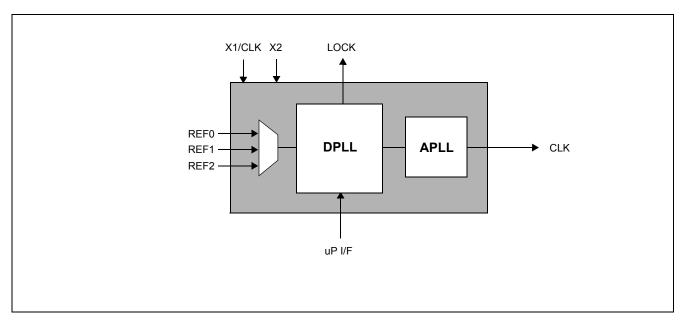


Figure 1 - Block Diagram

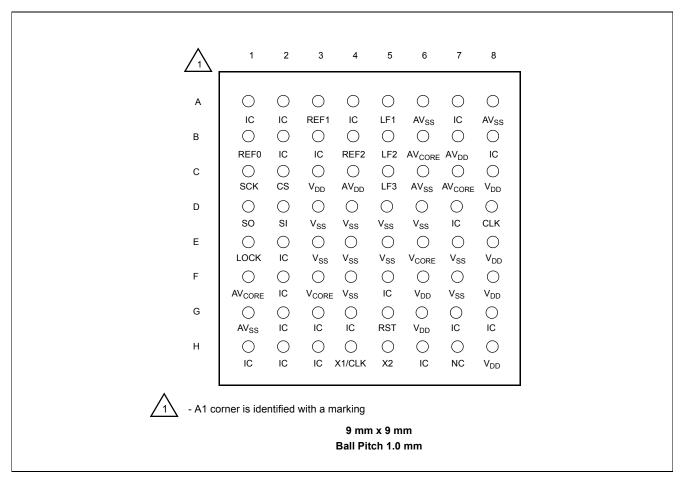


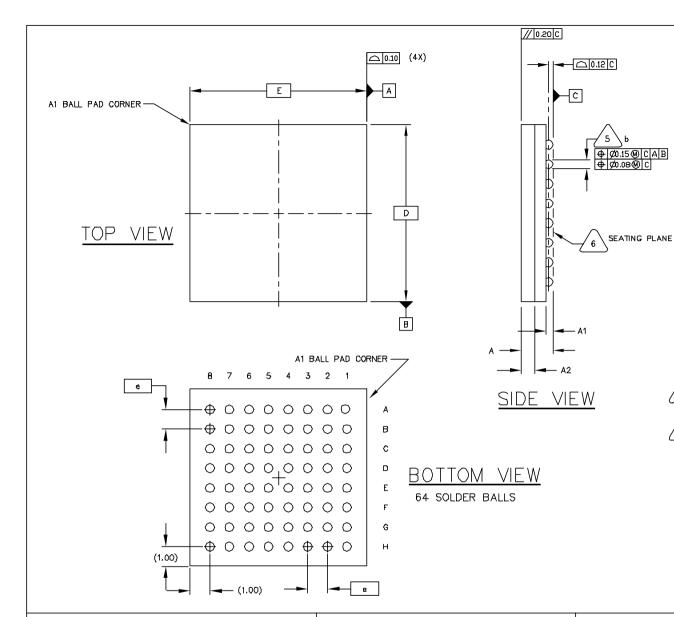
Figure 2 - Pin Connections

### **Pin Description**

Pin#	Name	I/O Type	Description	
B1 A3 B4	REF0 REF1 REF2	I <sub>d</sub>	Reference Inputs (LVCMOS, Schmitt Trigger). These reference inputs are used for synchronizing the PLL. These pins are internally pulled down to Vss.	
D8	CLK	0	SONET/SDH/Ethernet Clock Output (LVCMOS). This output clock is configurable as 77.76 MHz, 25 MHz, and 50 MHz. Default is 77.76 MHz.	
G5	RST	I	<b>Reset (LVCMOS, Schmitt Trigger).</b> A logic low at this input resets the device. To ensure proper operation, the device must be reset after power-up. Reset should be asserted for a minimum of 300 ns.	
E1	LOCK	0	<b>Lock Indicator (LVCMOS).</b> This is the lock indicator pin for the PLL. This output goes high when the DPLL's output is frequency is phase locked to the input reference.	
A5	LF1	А	External Analog PLL Loop Filter terminal.	
B5	LF2	Α	Analog PLL External Loop Filter Reference.	
C5	LF3	Α	Analog PLL External Loop Filter Reference.	
H4	X1/CLK	I	Oscillator Master Clock Input (LVCMOS). This input accepts a 20 MHz reference from a clock oscillator (XO, XTAL). The stability and accuracy of the clock at this input determines the free-run accuracy and the long term holdover stability of the output clocks.	
H5	X2	0	Oscillator Master Clock Output (LVCMOS). This pin is used for connection with an crystal. This pin must be left unconnected when the X1 pin is connected to a clock oscillator.	
C1	SCK	I	Clock for Serial Interface (LVCMOS). Serial interface clock.	
D2	SI	I	Serial Interface Input (LVCMOS). Serial interface data input pin.	
D1	SO	0	Serial Interface Output (LVCMOS). Serial interface data output pin.	
C2	CS	l <sub>u</sub>	Chip Select for Serial Interface (LVCMOS). Serial interface chip select. This pin is internally pulled up to Vdd.	
F5 A1 A2 A4 A7 B8 D7 E2 G7 H1 B2 G4 G2 G3 G8 H3 F2	IC		Internal Connection. Leave unconnected.	

Pin#	Name	I/O Type	Description
H6 B3 H2	IC		Internal Connection. Connect to ground.
H7	NC		No Connection. Leave unconnected.
C3 C8 E8 F6 F8 G6 H8	V <sub>DD</sub>	P P P P P	Positive Supply Voltage. +3.3 V <sub>DC</sub> nominal.
E6 F3	V <sub>CORE</sub>	P P	Positive Supply Voltage. +1.8 V <sub>DC</sub> nominal.
B7 C4	AV <sub>DD</sub>	P P	Positive Analog Supply Voltage. +3.3 V <sub>DC</sub> nominal.
B6 C7 F1	AV <sub>CORE</sub>	P P P	Positive Analog Supply Voltage. +1.8 V <sub>DC</sub> nominal.
D3 D4 D5 D6 E3 E4 E5 E7 F4	V <sub>SS</sub>	G G G G G G G	Ground. 0 Volts.
A6 A8 C6 G1	AV <sub>SS</sub>	G G G	Analog Ground. 0 Volts.

- I Input
- I<sub>d</sub> Input, Internally pulled down
- Iu Input, Internally pulled up
- O Output
- A Analog
- P Power
- G Ground



OVA IDAT	MILLIMETER				
SYMBOL	MIN	NOM	MAX		
A	1.52	1.62	1.72		
A1	0.31	0.36	0.41		
AS	0.65	0.70	0.75		
Ъ	0.46 Typ.				
D	9.00 REF.				
Е	9.00 Ref.				
е	1.0 Ref				
n	64				

PRIMARY DATUM C AND SEATING PLANE ARE DEFINED BY THE SPHERICAL CROWNS OF THE SOLDER BALLS.

DIMENSION 6 IS MEASURED AT THE MAXIMUM SOLDER BALL DIAMETER, PARALLEL TO PRIMARY DATUM C.

4. THE MAXIMUM ALLOWABLE NUMBER OF SOLDER BALLS IS 64.

3. Not to Scale.

2, THE BASIC SOLDER BALL GRID PITCH IS 1.00mm.

ALL DIMENSIONS AND TOLERANCES CONFORM TO ASME Y14.5M-1994.

NOTES: UNLESS OTHERWISE SPECIFIED

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ISSUE	1			
ACN	CDCA			
DATE	15April05			
APPRD.				



Package Code GG
Package Outline for 64ball
9x9mm, 1.0 mm Pitch, 4 layer, CABGA
111039



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